# Customer: ART

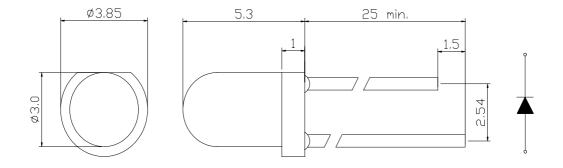
### **Benefits:**

- High intensity
- Low power consumption
- Solid state reliability
- Optimal optical and mechanical design

### **Package Dimensions:**

### Features:

- 3.0\*5.3mm lamp LED
- Lens color: White diffused
- Emitting color: Yellow green, AlGaInP
- Viewing angle: 60°



### Notes:

- All dimensions are in millimeters
- Tolerance is  $\pm 0.25$  mm unless otherwise noted.
- Specifications are subject to change without notice

### Absolute Maximum Ratings At Ta=25°C

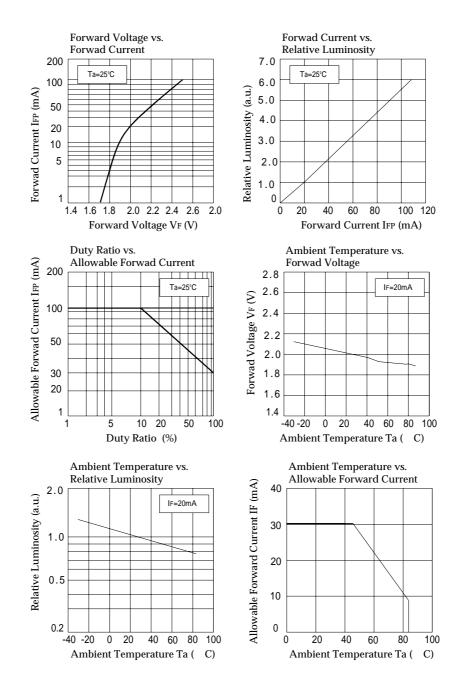
Parameter	Symbol	Ratings	Unit		
Power Dissipation	Pd	60	mW		
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	Ifp	100	mA		
Forward Current	If	30	mA		
Reverse Voltage	Vr	5	V		
Soldering Temperature Range	Tsol	Reflow soldering for 260°C within 10s Hand soldering for 300°C within 3s			
Operating Temperature Range	Topr	-30°C to + 85°C			
Storage Temperature Range	Tstg	-40°C to + 85	°C		

## Customer: ART

### Part no.: AL-M30G

Clectrical/Optical Characteristics At Ta=25°C							
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Luminous Intensity	Iv		120		mcd	I <sub>F</sub> =20mA	
Viewing Angle	$2\theta_{1/2}$		60		Deg.	I <sub>F</sub> =20mA	
Dominant Wavelength	λd		570		nm	I <sub>F</sub> =20mA	
Forward Voltage	$V_{\rm F}$	1.8		2.4	V	I <sub>F</sub> =20mA	
Reverse Current	I <sub>R</sub>			10	μΑ	$V_R = 5V$	

### Electrical/Optical Characteristics At Ta=25°C



# Customer: ART

### **Precautions for use:**

1.Lead Forming & Assembly

- Any lead forming or bending must be done before soldering, at normal temperature.
- When forming leads, there must be a minimum of 3mm clearance between the base of the LED lens and the lead bend.
- Do not use the base of the lead frame as a fulcrum during lead forming.
- Avoid bending the leads at the same point more than once.
- During assembly onto PCB, the lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement.
- 2.Cleaning:
  - Isopropyl alcohol or deionized water are recommended solvents for cleaning. When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the resin or not. 3.Storage
  - The storage ambient for the LEDs should not exceed  $30^{\circ}$ C temperature or 70% relative humidity.
  - It is recommended that LEDs out of their original packaging are used within three months. For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.
- 4.ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

The following procedures may decrease the possibility of ESD damage.

- All production machinery and test instruments must be electrically grounded.
- Use a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- Maintain a humidity level of 50% or higher in production areas.
- Use anti-static packaging for transport and storage.